

# **Multi- function LCD Segment Drivers**

Key Matrix

BU97501KV MAX 204 Segment (51SEGx4COM)

#### **Features**

- Key input function for up to 30 keys (A key scan is performed only when a key is pressed.)
- Either 1/4 or 1/3 Duty can be selected 1/4 Duty drive: Up to 204 segments 1/3 Duty drive: Up to 156 segments
- Integrated RAM for display data (DDRAM)
- Segment/GPO (Max 4port) output mode selectable
- Support standby mode
- Integrated Power-on Reset circuit
- Integrated Oscillator circuit
- No external component
- Low power consumption design

# **Applications**

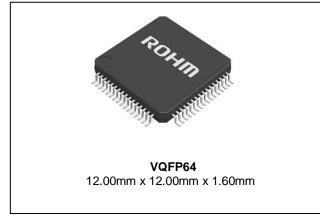
- Telephone
- FAX
- Portable equipment (POS, ECR, PDA etc.)
- DSC
- DVC
- Car audio
- Home electrical appliance
- Meter equipment

# **Key Specifications**

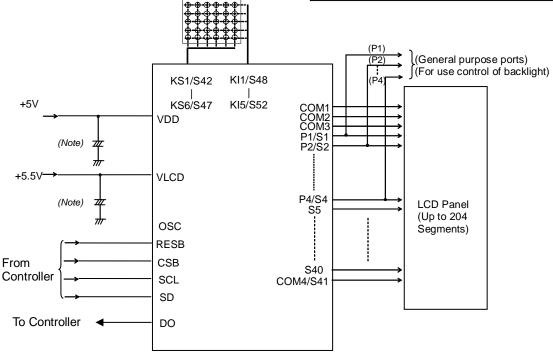
Supply Voltage Range: 2.7V to 6.0V
LCD drive power supply Range: 4.5V to 6.0V
Operating Temperature Range: -40°C to +85°C
Max Segments: 204 Segments
Display Duty: 1/3, 1/4 selectable
Bias: 1/2, 1/3 selectable
Interface: 3wire serial interface

# **Package**

VQFP64 W (Typ) x D (Typ) x H (Max)



# **Typical Application Circuit**



(Note) Insert capacitors between VDD/VLCD and VSS C≥0.1µF.

Figure 1. Typical Application Circuit

# **Block Diagram / Pin Configuration / Pin Description**

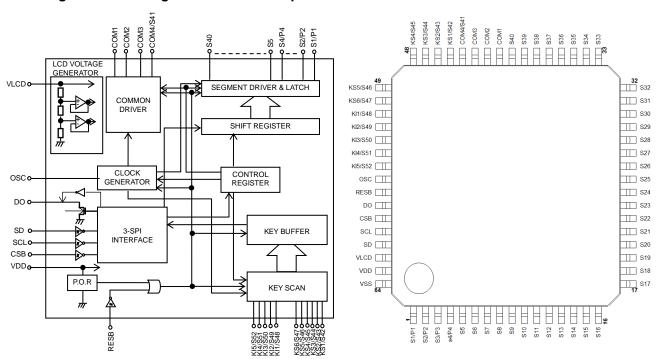


Figure 2. Block Diagram

Figure 3. Pin Configuration (TOP VIEW)

	I		T	
Terminal	Terminal No.	I/O	Handling When Unused	Functions
CSB	59	ı	VDD	Chip select : "L" active
SCL	60	I	VSS	Serial data transfer clock
SD	61	ı	VSS	Input serial data
VDD	63	-	-	Power Supply for the logic
osc	56	I	OPEN/VSS	External Clock Input: Fix to low or open when the internal clock mode setting.
DO	58	0	OPEN	Output data
RESB	57	I	VDD	Reset Input: RESB="L": Display is disabled. RESB="H": Display is controllable. However, serial data cannot be transferred when RESB is "L".
VSS	64	-	-	Power supply pin. Must be connected to Ground.
VLCD	62	-	-	Power Supply for the LCD driver
COM1 to COM3	41 to 43	0	OPEN	COMMON output for LCD driver
COM4/S41	44	0	OPEN	COMMON / SEGMENT output for LCD driver. Assigned as SEGMENT output in 1/3Duty mode.
S1/P1 to S4/P4	1 to 4	0	OPEN	SEGMENT output for LCD driving / General Purpose Output S1/P1 to S4/P4 pins can also be used as General Purpose Outputs when set up by the control data.
S5 to S40	5 to 40	0	OPEN	SEGMENT output for LCD driver
KS1/S42 to KS6/S47	45 to 50	0	OPEN	Key scan outputs Although normal key scan timing lines require diodes to be inserted in the timing lines to prevent shorts, since these outputs are unbalanced CMOS transistor outputs, these outputs will not be damaged by shorting when these outputs are used to form a key matrix.  The KS1/S42 to KS6/S47 pins can be used as segment outputs when specified by the control data.
KI1/S48 to KI5/S52	51 to 55	I O	VSS OPEN	Key scan inputs These pins have built-in pull-down resistors. The KI1/S48 to KI5/S52 pins can be used as segment outputs when specified by the control data.

**Table 1. Pin Description** 

Absolute Maximum Ratings (VSS=0.0V)

Parameters	Symbol	Ratings	Unit	Remarks
Power Supply voltage 1	VDD	-0.5 to +7.0	V	Power supply
Power Supply voltage 2	VLCD	-0.5 to +7.0	V	LCD drive voltage
Power Dissipation	Pd	1.00 <sup>(Note 1)</sup>	W	
Input voltage range	V <sub>IN</sub>	-0.5 to VDD+0.5	V	
Storage temperature range	Tstg	-55 to +125	°C	

(Note 1) When operated higher than Ta=25°C, subtract 10mW per degree. (Using ROHM standard board)

(Board size: 70mmx70mmx1.6mm material: FR4 board copper foil: land pattern only)

Caution1: Operating the IC over the absolute maximum ratings may damage the IC. The damage can either be a short circuit between pins or an open circuit between pins and the internal circuitry. Therefore, it is important to consider circuit protection measures, such as adding a fuse, in case the IC is operated over the absolute maximum ratings.

Caution2: Should by any chance the maximum junction temperature rating be exceeded the rise in temperature of the chip may result in deterioration of the properties of the chip. In case of exceeding this absolute maximum rating, design a PCB with power dissipation taken into consideration by increasing board size and copper area so as not to exceed the maximum junction temperature rating.

Recommended Operating Conditions (VSS=0.0V)

Doromotoro	Cymbol		Ratings		Unit	Remarks	
Parameters	Symbol	Min	Тур	Max	Unit	Remarks	
Operating temperature	Topr	-40	-	+85	°C		
Power Supply voltage 1	VDD	2.7	-	6.0	V	Power supply	
Power Supply voltage 2	VLCD	4.5	-	6.0	V	LCD driver voltage	

(Note 2) The power supply condition shall be met  $VLCD \ge VDD$ .

#### **Electrical Characteristics**

(Unless otherwise specified, Ta=-40°C to +85°C, VDD=2.7 to 6.0V, VLCD=4.5 to 6.0V, VSS=0.0V)

Parameters	Symbol		Limits		Unit	Conditions
	Symbol	Min	Тур	Max	Offic	Conditions
"H" Input Voltage	V <sub>IH</sub>	0.7VDD	-	VDD	V	SD, SCL, CSB, RESB, OSC
"L" Input Voltage	$V_{IL}$	VSS	-	0.3VDD	V	SD, SCL, CSB, RESB, OSC
"H" Input Current	I <sub>IH</sub>	-	-	5.0	μΑ	SD, SCL, CSB, RESB, OSC, V <sub>I</sub> =5.5V
"L" Input Current	I <sub>IL</sub>	-5.0	-	-	μΑ	SD, SCL, CSB, RESB, OSC, V <sub>I</sub> =0.0V
Input Floating Voltage	$V_{IF}$	-	-	0.05VDD	V	KI1 to KI5
Pull-down Resistance	R <sub>PD</sub>	50	100	250	kΩ	KI1 to KI5, VLCD=5.0V
Output Off Leakage Current	I <sub>OFFH</sub>	-	-	6.0	μA	DO, V <sub>O</sub> =5.5V
	$V_{OH1}$	VLCD-1.0	-	-		P1 to P4, I <sub>O</sub> =-1mA
"H" Level Output Voltage	V <sub>OH2</sub>	VLCD-1.0	-	-	V	S1 to S52, I <sub>O</sub> =-20µA
H Level Output voltage	V <sub>OH3</sub>	VLCD-1.0	-	-	V	COM1 to COM4, I <sub>O</sub> =-100µA
	$V_{OH4}$	VLCD-1.0	-	-		KS1 to KS6, I <sub>0</sub> =-500μA
	V <sub>OL1</sub>	-	-	1.0		P1 to P4, I <sub>O</sub> =1mA
	$V_{OL2}$	-	-	1.0		S1 to S52, I <sub>0</sub> =20μA
"L" Level Output Voltage	$V_{OL3}$	-	-	1.0	V	COM1 to COM4, I <sub>O</sub> =100µA
	V <sub>OL4</sub>	-	-	1.0		KS1 to KS6, I <sub>O</sub> =25μA
	$V_{OL5}$	-	-	0.5		DO, I <sub>O</sub> =1mA
	$V_{MID1}$	1/2VLCD		1/2VLCD		S1 to S52
	V MID1	-1.0		+1.0		1/2 Bias, I <sub>O</sub> =±20μA
	$V_{MID2}$	1/2VLCD	_	1/2VLCD		COM1 to COM4
	V MID2	-1.0		+1.0		1/2 Bias, I <sub>O</sub> =±100µA
	$V_{MID3}$	2/3VLCD	_	2/3VLCD		S1 to S52
LCD Bias Voltage	V MID3	-1.0		+1.0	V	1/3 Bias, I <sub>0</sub> =±20μA
LOD Blas Voltage	$V_{MID4}$	1/3VLCD	_	1/3VLCD	V	S1 to S52
	V WIID4	-1.0		+1.0		1/3 Bias, I <sub>O</sub> =±20μA
	V <sub>MID5</sub>	2/3VLCD	_	2/3VLCD		COM1 to COM4
	COUNT .	-1.0		+1.0		1/3Bias, I <sub>O</sub> =±100μA
	$V_{MID6}$	1/3VLCD	-	1/3VLCD		COM1 to COM4
	- IVIDO	-1.0		+1.0		1/3 Bias, I₀=±100µA

#### **Electrical Characteristics - continued**

Parameters	Symbol	Limits			Unit	Conditions	
Farameters	Symbol	Min	Тур	Max	Offic	Conditions	
	Ist <sub>VDD</sub>	-	1	5		Input Pin ALL "L" Display off, Disable oscillator	
	Ist <sub>VLCD</sub>	-	1	5		Input Pin ALL "L" Display off, Disable oscillator	
Current Consumption	I <sub>VDD1</sub>	-	2	10	μΑ	VDD=VLCD=5.0V, Output unloaded f <sub>FR</sub> =80Hz	
	I <sub>VLCD1</sub>	-	40	95		VDD=VLCD=5.0V,Output unloaded 1/2 Bias, f <sub>FR</sub> =80Hz	
	I <sub>VLCD2</sub>	-	65	140		VDD=VLCD=5.0V, Output unloaded 1/3 Bias, f <sub>FR</sub> =80Hz	

Oscillation Characteristics (Ta=-40°C to +85°C, VDD=2.7 to 6.0V, VLCD=4.5V to 6.0V, VSS=0.0V)

Parameters	Symbol		Limits		Unit	Conditions		
Farameters	Symbol	Min	Тур	Max	Offic			
Frame Frequency1	f <sub>FR1</sub>	56	80	104	Hz	VLCD=4.5V to 6.0V, f <sub>FR</sub> = 80Hz setti		
Frame Frequency2	f <sub>FR2</sub>	68	80	92	Hz	VLCD=5.0V, f <sub>FR</sub> = 80Hz setting		
External Clock Frequency	f <sub>FR3</sub>	30	-	600	kHz			
External Clock Rise Time	tr	-	-	80	ns	External clock mode		
External Clock Fall Time	tf	-	-	80	ns	(DRV CTRL1 setting : P2P1=11)		
External Clock Duty	t <sub>DTY</sub>	30	50	70	%			

Frame frequency is decided external frequency and dividing ratio of DRV CTRL1 setting.

# [Reference Data]

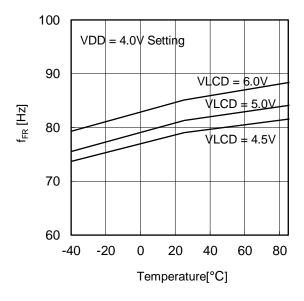


Figure 4. Frame Frequency Typical temperature characteristics

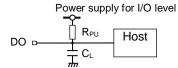
# **Electrical Characteristics – continued**

MPU Interface Characteristics (Ta=-40 to +85°C, VDD=2.7V to 6.0V, VLCD=4.5 to 6.0V, VSS=0.0V)

Parameters	Symbol		Limits		Unit	Conditions
Parameters	Symbol	MIN	TYP	MAX	Offit	Conditions
Input Rise Time	tr	-	-	80	ns	
Input Fall Time	tf	-	-	80	ns	
SCL Cycle Time	tscyc	400	-	-	ns	
"H" SCL Pulse Width	t <sub>SHW</sub>	100	-	-	ns	
"L" SCL Pulse Width	t <sub>SLW</sub>	100	-	-	ns	
SD Setup Time	t <sub>SDS</sub>	20	-	-	ns	
SD Hold Time	t <sub>SDH</sub>	20	-	-	ns	
CSB Setup Time	tcss	50	-	-	ns	
CSB Hold Time	t <sub>CSH</sub>	50	-	-	ns	
"H" CSB Pulse Width	t <sub>CHW</sub>	50	-	-	ns	
DO Output Delay Time	t <sub>DC</sub>	-	-	1.5	μs	DO R <sub>PU</sub> =4.7k $\Omega$ , C <sub>L</sub> =10pF <sup>(Note)</sup>
DO Rise Time	t <sub>DR</sub>	-	-	1.5	μs	DO R <sub>PU</sub> =4.7kΩ, C <sub>L</sub> =10pF <sup>(Note)</sup>

(Note) Since DO can be an open-drain output; these values depend on the resistance of the pull-up resistor RPU and the load capacitance CL. R<sub>PU</sub>: 1kΩ≤R<sub>PU</sub>≤10kΩ is recommended.

C<sub>L</sub>: A parasitic capacitance to VSS in an application circuit. Any component is not necessary to be attached.



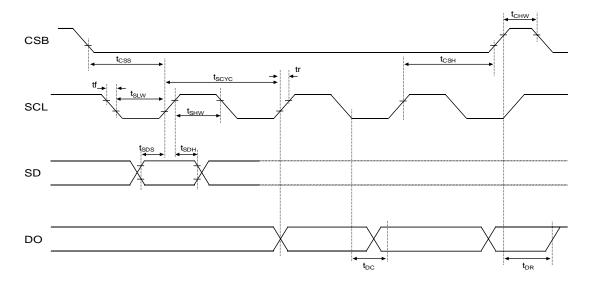


Figure 5. 3-wire Serial Interface Timing

# I/O equivalent circuit

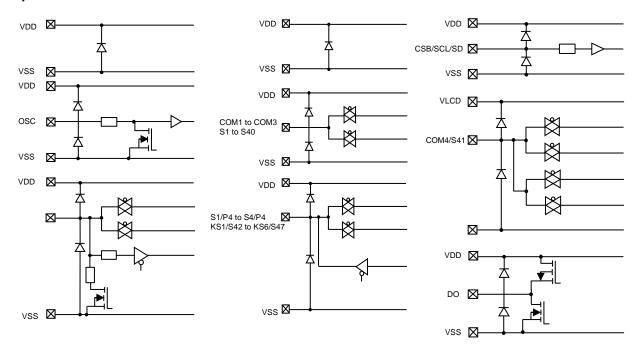


Figure 6. I/O equivalent circuit

#### **Function descriptions**

Command and Data Transfer Method

3-SPI (3-wire Serial Interface)

This device is controlled by a 3-wire signal (CSB, SCL, and SD).

First, Interface counter is initialized with CSB="H"

Setting CSB="L" enables SD and SCL inputs.

First, Interface counter is initialized with CSB="H", and then CSB="L" makes SD and SCL input enable.

The protocol of 3-SPI transfer is shown as follows.

Each command starts with D7 bit as MSB data, followed by D6 to D0 (this is while CSB ="L").

(Internal data is latched at the rising edge of SCL, then the data is converted to an 8-bit parallel data at the falling edge of the 8th CLK.)

When you rise CSB = "H", in case command less than 8bit, command and data are canceled.

#### (1) Write Mode

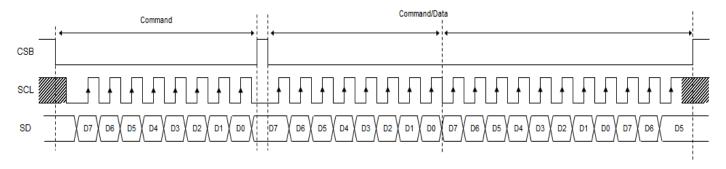


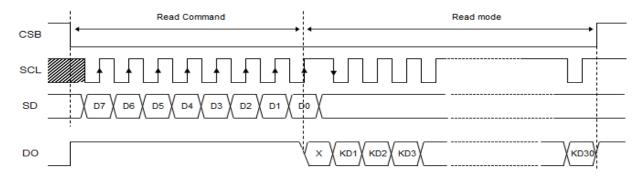
Figure 7. 3-SPI Data Transfer Format

#### (2) Read Mode (KEY RD command only)

The following occurs when Key Read by KEY RD command.

If KEY RD command is recognized at the rising edge of 8th CLK, it enters Read mode after the falling edge of 8th CLK and then key data is output through DO.

Setting CSB="H" can exit Read mode after or during Serial Data Transfer.



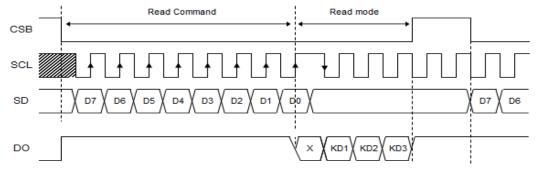


Figure 8. Serial Data Output Format

# Function descriptions - continued

Command Transfer Method

After CSB="H"→"L", the 1st byte shall be a command.

Please refer to "Command Table".

When set command except Data write(DATAWR), the next byte will be (continuously) a command.

When set DATAWR command, the following bytes will be display data bytes.

Command	Command	Command	Command	Display Data	
			(DATAWR)		

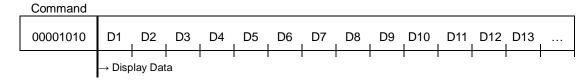
Once it becomes display data transfer mode, it will not be able to send command.

If you send command again, please rise CSB="H".

#### Display Data Transfer Method

This LSI has Display Data RAM (DDRAM) of 51x4=204bit.

The relationship between data input and display data, DDRAM data and address are as follows.



Display data will be stored in DDRAM. The address to be written is specified by Address set (ADSET) command and the address is automatically incremented in every 4bit data if 1/4 Duty mode or in every 3 bit if 1/3 Duty mode respectively.

#### 1/3 Duty Mode

#### DDRAM Address/Segment Outputs

		00h	01h	02h	•••	27h	28h	29h	•••	31h	32h	33h	_
	0	D1	D4	D7		D118	D121	D124		D148	D151	D154	COM1
BIT	1	D2	D5	D8		D119	D122	D125		D149	D152	D155	COM2
	2	D3	D6	D9		D120	D123	D126		D150	D153	D156	сомз
		S1	S2	S3		S40	S41	S42		S50	S51	S52	•

Transferred data is written to the DDRAM by every 3bits. The write operation is cancelled if it changes CSB="L" $\rightarrow$ "H" before 3bits data transfer.

#### 1/4 Duty Mode

#### DDRAM Address/ Segment Outputs

		00h	01h	02h	•••	27h	28h	29h	•••	30h	31h	32h	
	0	D1	D5	D9		D157	D161	D165		D193	D197	D201	COM1
ВІТ	1	D2	D6	D10		D158	D162	D166		D194	D198	D202	COM2
ы	2	D3	D7	D11		D159	D163	D167		D195	D199	D203	сомз
	3	D4	D8	D12		D160	D164	D168		D196	D200	D204	COM4
	•	S1	S2	S3		S40	S42	S43		S50	S51	S52	_

Transferred Data is written to the DDRAM by every 4bits. The write operation is cancelled if it changes CSB="L"→"H" before 4bits data transfer.

# Function descriptions - continued

Relationship between Display Data and Segment Output Pins

B Duty Mode output terminal	COM1	COM2	сомз	Address (Hex)
S1/P1	D1	D2	D3	00
S2/P2	D4	D5	D6	01
S3/P3	D7	D8	D9	02
S4/P4	D10	D11	D12	03
S5	D13	D14	D15	04
S6	D16	D17	D18	05
S7	D19	D20	D21	06
S8	D22	D23	D24	07
S9	D25	D26	D27	08
S10	D28	D29	D30	09
S11	D31	D32	D33	0A
S12	D34	D35	D36	0B
S13	D37	D38	D39	0C
S14	D40	D41	D42	0D
S15	D43	D44	D45	0E
S16	D46	D47	D48	0F
S17	D49	D50	D51	10
S18	D52	D53	D54	11
S19	D55	D56	D57	12
S20	D58	D59	D60	13
S21	D61	D62	D63	14
S22	D64	D65	D66	15
S23	D67	D68	D69	16
S24	D70	D71	D72	17

D74

D77

output	2014	00140	00140	Address
terminal	COM1	COM2	COM3	(Hex)
S27	D79	D80	D81	1A
S28	D82	D83	D84	1B
S29	D85	D86	D87	1C
S30	D88	D89	D90	1D
S31	D91	D92	D93	1E
S32	D94	D95	D96	1F
S33	D97	D98	D99	20
S34	D100	D101	D102	21
S35	D103	D104	D105	22
S36	D106	D107	D108	23
S37	D109	D110	D111	24
S38	D112	D113	D114	25
S39	D115	D116	D117	26
S40	D118	D119	D120	27
COM4/S41	D121	D122	D123	28
KS1/S42	D124	D125	D126	29
KS2/S43	D127	D128	D129	2A
KS3/S44	D130	D131	D132	2B
KS4/S45	D133	D134	D135	2C
KS5/S46	D136	D137	D138	2D
KS6/S47	D139	D140	D141	2E
KI1/S48	D142	D143	D144	2F
KI2/S49	D145	D146	D147	30
KI3/S50	D148	D149	D150	31
KI4/S51	D151	D152	D153	32
KI5/S52	D154	D155	D156	33

(Note) In case of S1/P1 to S4/P4, COM4/S41, KS1/S42 to KS6/S47 and KI1/S48 to KI5/S52 are selected for segment output.

18

19

D75

D78

For example, S11 output case

D73

D76

S25

S26

Bi	ts in a DDR	ΑM	Commont Output Din (C44)					
D31	D32	D33	Segment Output Pin (S11)					
0	0	0	Off-state of the LCD elements corresponding to COM1, 2 and 3					
0	0	1	On-state of the LCD element corresponding to COM3					
0	1	0	On-state of the LCD element corresponding to COM2					
0	1	1	On-state of the LCD elements corresponding to COM2 and 3					
1	0	0	On-state of the LCD element corresponding to COM1					
1	0	1	On-state of the LCD elements corresponding to COM1 and 3					
1	1	0	On-state of the LCD elements corresponding to COM1 and 2					
1	1 1 1		On-state of the LCD elements corresponding to COM1, 2 and 3					

# Function descriptions – continued 1/4 Duty Mode

terminal         COM1         COM2         COM3         COM4         (Hex)           S1/P1         D1         D2         D3         D4         00           S2/P2         D5         D6         D7         D8         01           S3/P3         D9         D10         D11         D12         02           S4/P4         D13         D14         D15         D16         03           S5         D17         D18         D19         D20         04           S6         D21         D22         D23         D24         05           S7         D25         D26         D27         D28         06           S8         D29         D30         D31         D32         07           S9         D33         D34         D35         D36         08           S10         D37         D38         D39         D40         09           S11         D41         D42         D43         D44         0A           S12         D45         D46         D47         D48         0B           S13         D49         D50         D51         D52         OC           S	1/4 Duty Mod	de <u>e</u>				
S2/P2         D5         D6         D7         D8         01           S3/P3         D9         D10         D11         D12         02           S4/P4         D13         D14         D15         D16         03           S5         D17         D18         D19         D20         04           S6         D21         D22         D23         D24         05           S7         D25         D26         D27         D28         06           S8         D29         D30         D31         D32         07           S9         D33         D34         D35         D36         08           S10         D37         D38         D39         D40         09           S11         D41         D42         D43         D44         0A           S12         D45         D46         D47         D48         0B           S13         D49         D50         D51         D52         OC           S14         D53         D54         D55         D56         OD           S15         D57         D58         D59         D60         0E           S16		COM1	COM2	сомз	COM4	Address (Hex)
S3/P3         D9         D10         D11         D12         O2           S4/P4         D13         D14         D15         D16         O3           S5         D17         D18         D19         D20         O4           S6         D21         D22         D23         D24         O5           S7         D25         D26         D27         D28         O6           S8         D29         D30         D31         D32         O7           S9         D33         D34         D35         D36         O8           S10         D37         D38         D39         D40         O9           S11         D41         D42         D43         D44         OA           S12         D45         D46         D47         D48         OB           S13         D49         D50         D51         D52         OC           S14         D53         D54         D55         D56         OD           S15         D57         D58         D59         D60         OE           S16         D61         D62         D63         D64         OF           S17	S1/P1	D1	D2	D3	D4	00
S4/P4         D13         D14         D15         D16         03           S5         D17         D18         D19         D20         04           S6         D21         D22         D23         D24         05           S7         D25         D26         D27         D28         06           S8         D29         D30         D31         D32         07           S9         D33         D34         D35         D36         08           S10         D37         D38         D39         D40         09           S11         D41         D42         D43         D44         0A           S12         D45         D46         D47         D48         0B           S13         D49         D50         D51         D52         OC           S14         D53         D54         D55         D56         OD           S15         D57         D58         D59         D60         OE           S16         D61         D62         D63         D64         OF           S18         D69         D70         D71         D72         11           S19	S2/P2	D5	D6	D7	D8	01
S5         D17         D18         D19         D20         04           S6         D21         D22         D23         D24         05           S7         D25         D26         D27         D28         06           S8         D29         D30         D31         D32         07           S9         D33         D34         D35         D36         08           S10         D37         D38         D39         D40         09           S11         D41         D42         D43         D44         0A           S12         D45         D46         D47         D48         0B           S13         D49         D50         D51         D52         OC           S14         D53         D54         D55         D56         OD           S15         D57         D58         D59         D60         OE           S16         D61         D62         D63         D64         OF           S17         D65         D66         D67         D68         10           S18         D69         D70         D71         D72         11           S19	S3/P3	D9	D10	D11	D12	02
S6         D21         D22         D23         D24         05           S7         D25         D26         D27         D28         06           S8         D29         D30         D31         D32         07           S9         D33         D34         D35         D36         08           S10         D37         D38         D39         D40         09           S11         D41         D42         D43         D44         0A           S12         D45         D46         D47         D48         0B           S13         D49         D50         D51         D52         0C           S14         D53         D54         D55         D56         0D           S15         D57         D58         D59         D60         0E           S16         D61         D62         D63         D64         0F           S17         D65         D66         D67         D68         10           S18         D69         D70         D71         D72         11           S19         D73         D74         D75         D76         12           S20	S4/P4	D13	D14	D15	D16	03
S7         D25         D26         D27         D28         06           S8         D29         D30         D31         D32         07           S9         D33         D34         D35         D36         08           S10         D37         D38         D39         D40         09           S11         D41         D42         D43         D44         0A           S12         D45         D46         D47         D48         0B           S13         D49         D50         D51         D52         OC           S14         D53         D54         D55         D56         OD           S15         D57         D58         D59         D60         OE           S16         D61         D62         D63         D64         OF           S17         D65         D66         D67         D68         10           S18         D69         D70         D71         D72         11           S19         D73         D74         D75         D76         12           S20         D77         D78         D79         D80         13           S21	S5	D17	D18	D19	D20	04
S8         D29         D30         D31         D32         07           S9         D33         D34         D35         D36         08           S10         D37         D38         D39         D40         09           S11         D41         D42         D43         D44         0A           S12         D45         D46         D47         D48         0B           S13         D49         D50         D51         D52         OC           S14         D53         D54         D55         D56         OD           S15         D57         D58         D59         D60         OE           S16         D61         D62         D63         D64         OF           S17         D65         D66         D67         D68         10           S18         D69         D70         D71         D72         11           S19         D73         D74         D75         D76         12           S20         D77         D78         D79         D80         13           S21         D81         D82         D83         D84         14           S22	S6	D21	D22	D23	D24	05
S9         D33         D34         D35         D36         08           S10         D37         D38         D39         D40         09           S11         D41         D42         D43         D44         OA           S12         D45         D46         D47         D48         OB           S13         D49         D50         D51         D52         OC           S14         D53         D54         D55         D56         OD           S15         D57         D58         D59         D60         OE           S16         D61         D62         D63         D64         OF           S17         D65         D66         D67         D68         10           S18         D69         D70         D71         D72         11           S19         D73         D74         D75         D76         12           S20         D77         D78         D79         D80         13           S21         D81         D82         D83         D84         14           S22         D85         D86         D87         D88         15           S23	S7	D25	D26	D27	D28	06
S10         D37         D38         D39         D40         09           S11         D41         D42         D43         D44         OA           S12         D45         D46         D47         D48         OB           S13         D49         D50         D51         D52         OC           S14         D53         D54         D55         D56         OD           S15         D57         D58         D59         D60         OE           S16         D61         D62         D63         D64         OF           S17         D65         D66         D67         D68         10           S18         D69         D70         D71         D72         11           S19         D73         D74         D75         D76         12           S20         D77         D78         D79         D80         13           S21         D81         D82         D83         D84         14           S22         D85         D86         D87         D88         15           S23         D89         D90         D91         D92         16           S24 <td>S8</td> <td>D29</td> <td>D30</td> <td>D31</td> <td>D32</td> <td>07</td>	S8	D29	D30	D31	D32	07
S11         D41         D42         D43         D44         OA           S12         D45         D46         D47         D48         OB           S13         D49         D50         D51         D52         OC           S14         D53         D54         D55         D56         OD           S15         D57         D58         D59         D60         OE           S16         D61         D62         D63         D64         OF           S17         D65         D66         D67         D68         10           S18         D69         D70         D71         D72         11           S19         D73         D74         D75         D76         12           S20         D77         D78         D79         D80         13           S21         D81         D82         D83         D84         14           S22         D85         D86         D87         D88         15           S23         D89         D90         D91         D92         16           S24         D93         D94         D95         D96         17           S25 <td>S9</td> <td>D33</td> <td>D34</td> <td>D35</td> <td>D36</td> <td>08</td>	S9	D33	D34	D35	D36	08
S12         D45         D46         D47         D48         OB           S13         D49         D50         D51         D52         OC           S14         D53         D54         D55         D56         OD           S15         D57         D58         D59         D60         OE           S16         D61         D62         D63         D64         OF           S17         D65         D66         D67         D68         10           S18         D69         D70         D71         D72         11           S19         D73         D74         D75         D76         12           S20         D77         D78         D79         D80         13           S21         D81         D82         D83         D84         14           S22         D85         D86         D87         D88         15           S23         D89         D90         D91         D92         16           S24         D93         D94         D95         D96         17           S25         D97         D98         D99         D100         18	S10	D37	D38	D39	D40	09
S13         D49         D50         D51         D52         OC           S14         D53         D54         D55         D56         OD           S15         D57         D58         D59         D60         OE           S16         D61         D62         D63         D64         OF           S17         D65         D66         D67         D68         10           S18         D69         D70         D71         D72         11           S19         D73         D74         D75         D76         12           S20         D77         D78         D79         D80         13           S21         D81         D82         D83         D84         14           S22         D85         D86         D87         D88         15           S23         D89         D90         D91         D92         16           S24         D93         D94         D95         D96         17           S25         D97         D98         D99         D100         18	S11	D41	D42	D43	D44	0A
S14         D53         D54         D55         D56         OD           S15         D57         D58         D59         D60         OE           S16         D61         D62         D63         D64         OF           S17         D65         D66         D67         D68         10           S18         D69         D70         D71         D72         11           S19         D73         D74         D75         D76         12           S20         D77         D78         D79         D80         13           S21         D81         D82         D83         D84         14           S22         D85         D86         D87         D88         15           S23         D89         D90         D91         D92         16           S24         D93         D94         D95         D96         17           S25         D97         D98         D99         D100         18	S12	D45	D46	D47	D48	0B
S15         D57         D58         D59         D60         OE           S16         D61         D62         D63         D64         OF           S17         D65         D66         D67         D68         10           S18         D69         D70         D71         D72         11           S19         D73         D74         D75         D76         12           S20         D77         D78         D79         D80         13           S21         D81         D82         D83         D84         14           S22         D85         D86         D87         D88         15           S23         D89         D90         D91         D92         16           S24         D93         D94         D95         D96         17           S25         D97         D98         D99         D100         18	S13	D49	D50	D51	D52	0C
S16         D61         D62         D63         D64         OF           S17         D65         D66         D67         D68         10           S18         D69         D70         D71         D72         11           S19         D73         D74         D75         D76         12           S20         D77         D78         D79         D80         13           S21         D81         D82         D83         D84         14           S22         D85         D86         D87         D88         15           S23         D89         D90         D91         D92         16           S24         D93         D94         D95         D96         17           S25         D97         D98         D99         D100         18	S14	D53	D54	D55	D56	0D
S17         D65         D66         D67         D68         10           S18         D69         D70         D71         D72         11           S19         D73         D74         D75         D76         12           S20         D77         D78         D79         D80         13           S21         D81         D82         D83         D84         14           S22         D85         D86         D87         D88         15           S23         D89         D90         D91         D92         16           S24         D93         D94         D95         D96         17           S25         D97         D98         D99         D100         18	S15	D57	D58	D59	D60	0E
S18         D69         D70         D71         D72         11           S19         D73         D74         D75         D76         12           S20         D77         D78         D79         D80         13           S21         D81         D82         D83         D84         14           S22         D85         D86         D87         D88         15           S23         D89         D90         D91         D92         16           S24         D93         D94         D95         D96         17           S25         D97         D98         D99         D100         18	S16	D61	D62	D63	D64	0F
S19         D73         D74         D75         D76         12           S20         D77         D78         D79         D80         13           S21         D81         D82         D83         D84         14           S22         D85         D86         D87         D88         15           S23         D89         D90         D91         D92         16           S24         D93         D94         D95         D96         17           S25         D97         D98         D99         D100         18	S17	D65	D66	D67	D68	10
S20         D77         D78         D79         D80         13           S21         D81         D82         D83         D84         14           S22         D85         D86         D87         D88         15           S23         D89         D90         D91         D92         16           S24         D93         D94         D95         D96         17           S25         D97         D98         D99         D100         18	S18	D69	D70	D71	D72	11
S21         D81         D82         D83         D84         14           S22         D85         D86         D87         D88         15           S23         D89         D90         D91         D92         16           S24         D93         D94         D95         D96         17           S25         D97         D98         D99         D100         18	S19	D73	D74	D75	D76	12
S22         D85         D86         D87         D88         15           S23         D89         D90         D91         D92         16           S24         D93         D94         D95         D96         17           S25         D97         D98         D99         D100         18	S20	D77	D78	D79	D80	13
S23         D89         D90         D91         D92         16           S24         D93         D94         D95         D96         17           S25         D97         D98         D99         D100         18	S21	D81	D82	D83	D84	14
S24         D93         D94         D95         D96         17           S25         D97         D98         D99         D100         18	S22	D85	D86	D87	D88	15
S25 D97 D98 D99 D100 18	S23	D89	D90	D91	D92	16
	S24	D93	D94	D95	D96	17
S26 D101 D102 D103 D104 19	S25	D97	D98	D99	D100	18
	S26	D101	D102	D103	D104	19

output					Address
terminal	COM1	COM2	СОМЗ	COM4	(Hex)
S27	D105	D106	D107	D108	1A
S28	D109	D110	D111	D112	1B
S29	D113	D114	D115	D116	1C
S30	D117	D118	D119	D120	1D
S31	D121	D122	D123	D124	1E
S32	D125	D126	D127	D128	1F
S33	D129	D130	D131	D132	20
S34	D133	D134	D135	D136	21
S35	D137	D138	D139	D140	22
S36	D141	D142	D143	D144	23
S37	D145	D146	D147	D148	24
S38	S38 D149		D151	D152	25
S39	D153	D154	D155	D156	26
S40	D157	D158	D159	D160	27
KS1/S42	D161	D162	D163	D164	28
KS2/S43	D165	D166	D167	D168	29
KS3/S44	D169	D170	D171	D172	2A
KS4/S45	D173	D174	D175	D176	2B
KS5/S46	D177	D178	D179	D180	2C
KS6/S47	D181	D182	D183	D184	2D
KI1/S48	D185	D186	D187	D188	2E
KI2/S49	D189	D190	D191	D192	2F
KI3/S50	D193	D194	D195	D196	30
KI4/S51	D197	D198	D199	D200	31
KI5/S52	D201	D202	D203	D204	32

(Note) In case of S1/P1 to S4/P4, KS1/S42 to KS6/S47 and KI1/S48 to KI5/S52 are selected for segment output.

For example, S11 output case

	Bits in the	DDRAM		Sogment Output Din (S11)				
D41	D42	D43	D44	Segment Output Pin (S11)				
0	0	0	0	Off-state of the LCD elements corresponding to COM1,2,3 and4				
0	0	0	1	On-state of the LCD element corresponding to COM4				
0	0	1	0	On-state of the LCD element corresponding to COM3				
0	0	1	1	On-state of the LCD elements corresponding to COM3 and 4				
0	1	0	0	On-state of the LCD element corresponding to COM2				
0	1	0	1	On-state of the LCD elements corresponding to COM2 and 4				
0	1	1	0	On-state of the LCD elements corresponding to COM2 and 3				
0	1	1	1	On-state of the LCD elements corresponding to COM2,3 and 4				
1	0	0	0	On-state of the LCD element corresponding to COM1				
1	0	0	1	On-state of the LCD elements corresponding to COM1 and 4				
1	0	1	0	On-state of the LCD elements corresponding to COM1 and 3				
1	0	1	1	On-state of the LCD elements corresponding to COM1, 3 and 4				
1	1	0	0	On-state of the LCD elements corresponding to COM1 and 2				
1	1	0	1	On-state of the LCD elements corresponding to COM1,2 and 4				
1	1	1	0	On-state of the LCD elements corresponding to COM1,2 and 3				
1 1 1 1			1	On-state of the LCD elements corresponding to COM1,2 3 and 4				

#### **Serial Data Output**

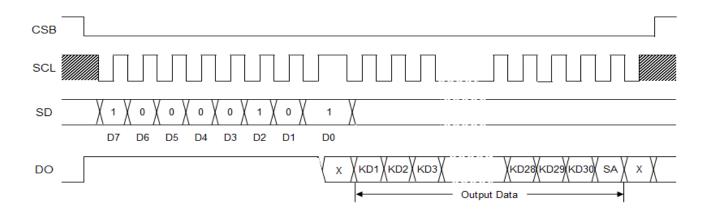


Figure 9. Serial Data Output

KD1 to KD30: Key Data SA: Sleep Acknowledge Data

Key Data Read Command (KEY RD): 1000\_0101 (Note) If a key data operation is executed when DO is high, the read key data (KD1 to KD30) and sleep acknowledge data(SA) will be invalid.

#### **Output Data**

#### KD1 to KD30: Key Data

When a key matrix of up to 30 keys is formed from the KS1 to KS6 output pins and the KI1 to KI5 input pins and one of those keys is pressed, the key output data corresponding to that key will be set to 1. The table shows the relationship between those pins and the key data bits.

	KI1	KI2	KI3	KI4	KI5
KS1	KD1	KD2	KD3	KD4	KD5
KS2	KD6	KD7	KD8	KD9	KD10
KS3	KD11	KD12	KD13	KD14	KD15
KS4	KD16	KD17	KD18	KD19	KD20
KS5	KD21	KD22	KD23	KD24	KD25
KS6	KD26	KD27	KD28	KD29	KD30

# SA: Sleep Acknowledge Data

This output data is used to set the state when the key is pressed. In this case, DO will go to the low level. If serial data is input during this period and the mode is set (normal mode or sleep mode), the IC will be set to that mode. SA is set to 0 in the sleep mode and to 1 in the normal mode.

#### **Key Scan Operation**

**Key Scan Timing** 

The key scan period is 288T(s). To reliably determine the on/off state of the keys, the BU97501KV scans the keys twice and determines that a key has been pressed when the key data agrees. It outputs a key data read request (a low level on DO) 615T(s) after starting a key scan. If the key data does not agree and a key is pressed at that point, it scans the keys again. Thus, BU97501KV cannot detect a key press shorter than 615T(s).

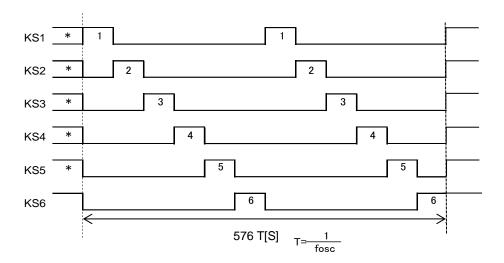


Figure 10. Key Scan Timing

#### Normal Mode

KS1/S42 - KS6/S47 pins are set high.

When a key is pressed, a key scan is started and the keys are scanned until all keys are released. Multiple key presses are recognized by determining whether multiple key data bits are set.

If a key is pressed for longer than 615 T(s) (Where  $T=1/f_{OSC}$  (When External clock input,  $f_{OSC}$  is a quarter of external clock)), the BU97501KV outputs a key data read request (a low level on DO) to the controller. The controller acknowledges this request and reads the key data. However, if CSB is "L" during a serial data transfer, DO will be set high.

After the controller reads the key data, the key data read request is cleared (DO is set high) and BU97501KV performs another key scan. Also note that DO can be controlled to be an open-drain output or a CMOS output. If set to be an open-drain output, a pull-up resistor (between  $1k\Omega$  and  $10k\Omega$ ) is required.

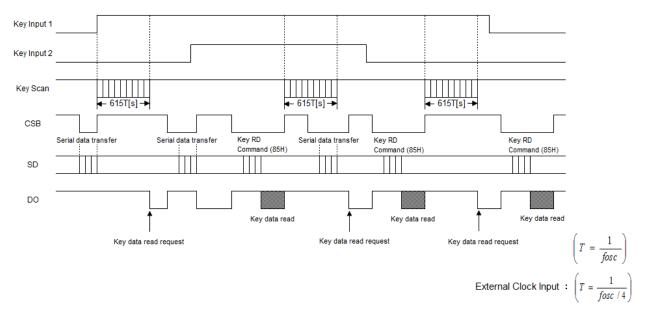


Figure 11. Key scan operation in normal mode

#### **Key Scan Operation – continued**

Sleep Mode

KS1/S42 - KS6/S47 pins are set high or low by SLP CTRL P3,P2 data. (Refer to the SLP CTRL description).

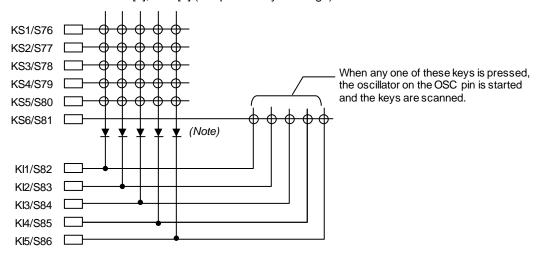
If a key on one of the lines corresponding to a KS1 to KS6 pin which is set high is pressed, the oscillator on the OSC pin is started and a key scan is performed. Keys are scanned until all keys are released. Multiple key presses are recognized by determining whether multiple key data bits are set.

If a key is pressed for longer than 615T(s)(Where T=1/f<sub>OSC</sub> (When External clock input, f<sub>OSC</sub> is a quarter of external clock)) the BU97501KV outputs a key data read request (a low level on DO) to the controller. The controller acknowledges this request and reads the key data. However, if CSB is "L" during a serial data transfer, DO will be set high.

After the controller reads the key data, the key data read request is cleared (DO is set high) and the BU97501KV performs another key scan. However, this does not clear sleep mode. Also note that DO can be controlled to be an open-drain output or a CMOS output. During open-drain output selection, DO is an open-drain output so a pull-up resistor (between 1 k $\Omega$  and 10k $\Omega$ ) is required.

Sleep mode key scan example

Example: when SLP CTRL P3= [0], P2= [1] (sleep with only KS6 high)



(Note) These diodes are required to reliably recognize multiple key presses on the KS6 line when sleep mode state with only KS6 high, as in the above example. That is, these diodes prevent incorrect operations due to sneak currents in the KS6 key scan output signal when keys on the KS1 to KS5 lines are pressed at the same time.

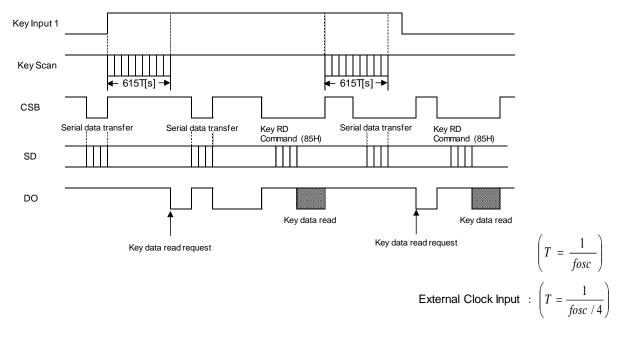


Figure 12. Key scan operation in sleep mode

#### **Multiple Key Presses**

Although the BU97501KV is capable of key scanning without inserting diodes for dual key presses, triple key presses on the KI1 to KI5 input pin lines, or multiple key presses on the KS1 to KS6 output pin lines, multiple presses other than these cases may result in keys that were not pressed recognized as having been pressed. Therefore, a diode must be inserted in series with each key. Applications that do not recognize multiple key presses of three or more keys should check the key data for three or more 1 bit and ignore such data.

#### **OSCILLATOR**

Several kinds of clock for logic and analog circuits are generated from internal oscillation circuit or external clock. The OSC pins are open or connected to VSS if the internal oscillator is used.

(Note) To use external clock mode, please set in DRVCTRL1 command. If you select "External Clock input", external clock can be inputted.

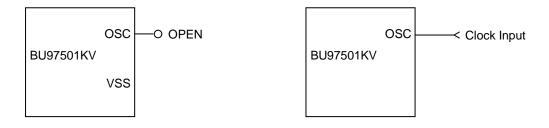


Figure 13. Internal clock mode

Figure 14. External clock mode

#### **LCD Driver Bias/Duty Circuit**

This LSI generates LCD driving voltage with on-chip Buffer AMP.

And it can drive LCD at low power consumption.

- \* 1/3 or 1/2Bias and line or frame inversion mode can be selected by DRV CTRL2.
- \* 1/4 or 1/3Duty can be selected by DRV CTRL1 command.

Refer to "LCD waveform" about each LCD waveform.

# LCD waveform

1/4Duty, 1/3Bias <u>Line inversion</u>

#### Frame inversion

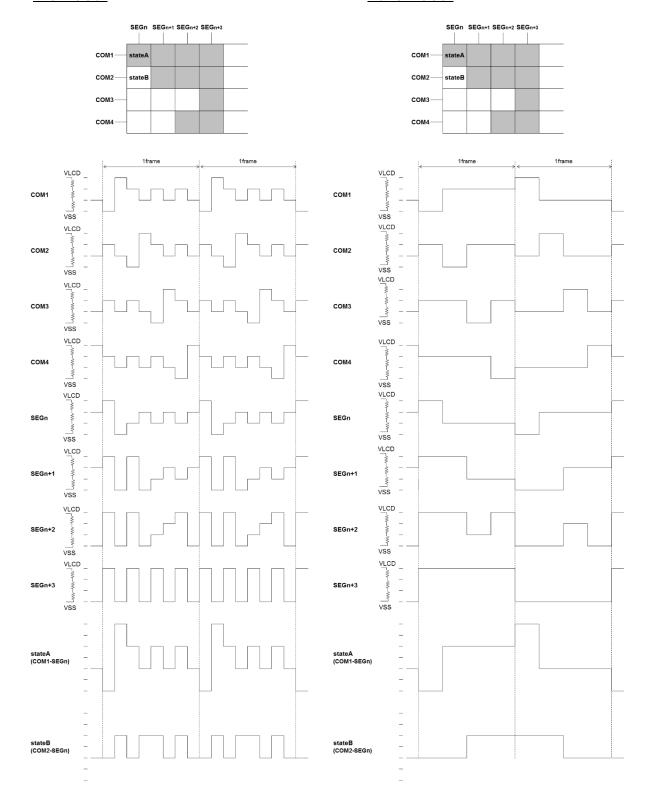


Figure 15. LCD waveform in line inversion

Figure 16. LCD waveform in frame inversion

#### LCD waveform - continued

1/4Duty, 1/2Bias Line inversion

#### Frame inversion

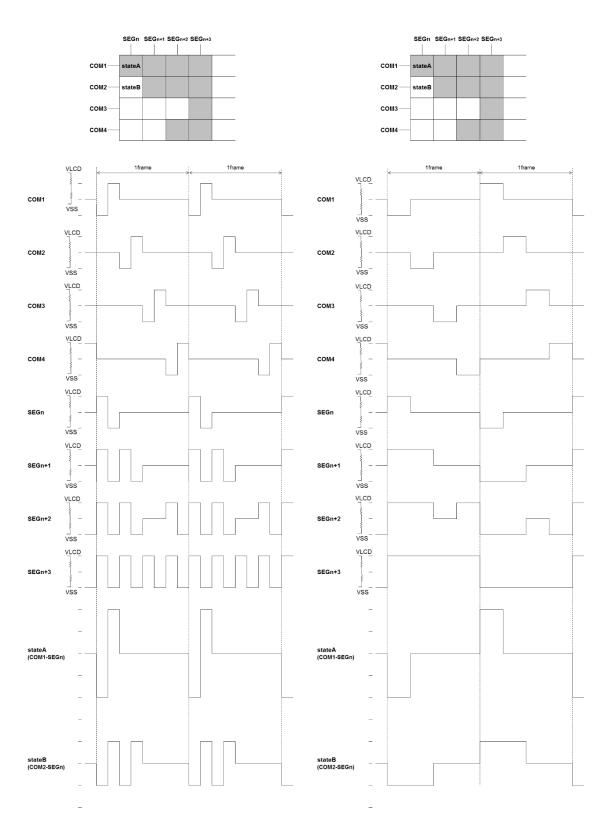


Figure 17. LCD waveform in line inversion

Figure 18. LCD waveform in frame inversion

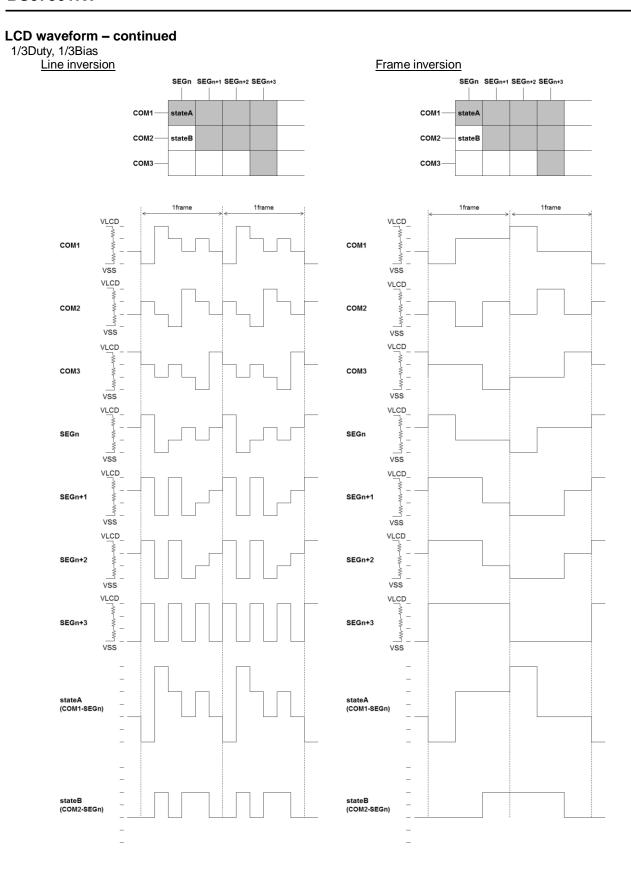


Figure 19. LCD waveform in line inversion

Figure 20. LCD waveform in frame inversion

#### LCD waveform - continued

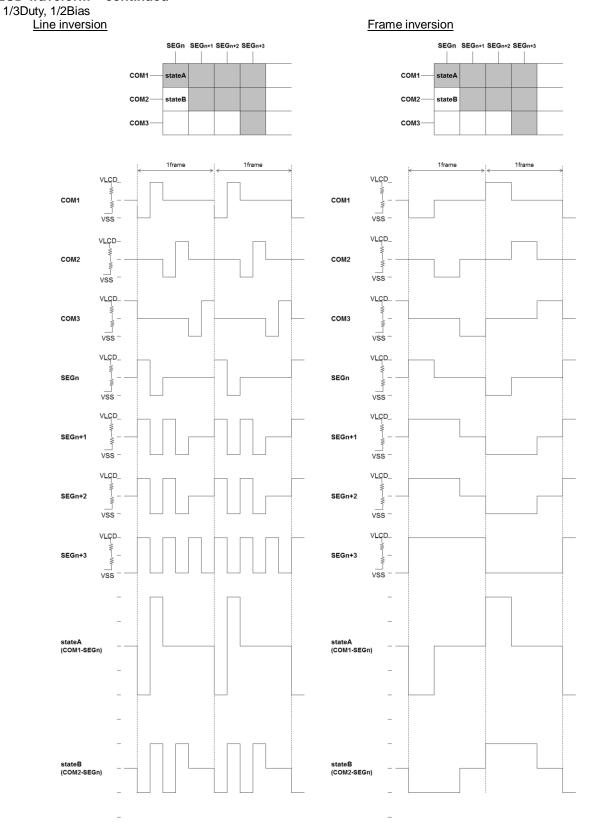


Figure 21. LCD waveform in line inversion

Figure 22. LCD waveform in frame inversion

# **Command Table**

Command.				В	IN				Dogorintiano
Command.	D7	D6	D5	D4	D3	D2	D1	D0	Descriptions
SLP CTRL	1	0	0	1	Р3	P2	*	*	Sleep Control
SEG CTRL	1	0	1	1	P3	P2	P1	*	Segment Control
DRV CTRL1	1	1	0	0	P3	P2	P1	0	Drive Control1 (Duty Set, OSC Control)
DRV CTRL2	1	1	0	1	0	P2	P1	0	Drive Control2 (Bias Set, Inversion Mode)
DRV CTRL3	1	0	1	0	P3	P2	*	P0	Drive Control3 (Keyscan Output Set, DO Set)
KEY RD	1	0	0	0	0	1	0	1	Key Data Read
SWRST	1	1	1	1	0	0	0	1	Software Reset
DISCTRL	1	1	1	1	1	0	P1	*	Display Control (Display On/Off)
ADSET	0	1	P5	P4	P3	P2	P1	P0	Address Set
DATA WR	0	0	0	0	1	0	1	0	Data Write

<sup>(\* :</sup> Don't care)

# **Detailed command description**

Sleep Control (SLP CTRL)

Ν	MSB												
	D7	D6	D5	D4	D3	D2	D1	D0					
	1	0	0	1	P3	P2	*	*					

(\*: Don't care)

P3, P2: Normal mode/Sleep mode switching control data

These control data bits select Key Scan Output Pins KS1 to KS6 States of during Key Scan Standby.

	Control bits		Mode	Internal OSC	Segment outputs/Commo	Ou	can	Reset Conditions				
	P3	P2		USC	n Outputs	KS1	KS2	KS3	KS4	KS5	KS6	Conditions
Ī	0	0	Normal	enabled	Operating	Н	Н	Н	Н	Ι	Ι	-
Ī	0	1	Sleep			L	L	L	L	L	Ι	0
Ī	1	0	Sleep	disabled	Low(VSS)	L	L	L	L	Ι	Ι	-
Ī	1	1	Sleep			Н	Н	Н	Н	Η	Η	-

(Note 1) When DRV CTRL3 (P3, P2) = (1, 1), KS1 to KS6 outputs are selected as Segment outputs.

# Segment Control (SEG CTRL)

Ν	MSB											
	D7	D6	D5	D4	D3	D2	D1	D0				
	1	0	1	1	P3	P2	P1	*				

(\*: Don't care)

P3 to P1: Segment Output / General purpose output switching control data These control bits select the function of the S1/P1 to S4/P4 output pins.

(Segment Output Pins or General Purpose Output Pins).

١.								
	C	ontrol b	its	9	Status of	Reset		
	P3	P2	P1	S1/P1	S2/P2	S3/P3	S4/P4	conditions
	0	0	0	S1	S2	S3	S4	0
	0	0	1	P1	S2	S3	S4	-
	0	1	0	P1	P2	S3	S4	-
	0	1	1	P1	P2	P3	S4	-
	1	0	0	P1	P2	P3	P4	-

(Note 2) Sn(n=1 to 4) : assigned as a Segment Output pin Pn(n=1 to 4) : assigned as a General Purpose Output pin

#### Relationship of bit assignment between general purpose output pin and bit in DDRAM

Outrout Dia	Corresponding bit in DDRAM					
Output Pin	1/3 Duty	1/4 Duty				
S1/P1	D1	D1				
S2/P2	D4	D5				
S3/P3	D7	D9				
S4/P4	D10	D13				

In case of 1/4 Duty mode and S4/P4 is configured as a general purpose output pins. S4/P4 is set to HIGH (VLCD level) if D13 is set to "1" in DDRAM. S4/P4 is cleared to LOW (VSS level) if D13 is set to "0" in DDRAM.

# Detailed command description - continued

Drive Control1 (DRV CTRL1)

Ν	MSB										
	D7	D6	D5	D4	D3	D2	D1	D0			
	1	1	0	0	P3	P2	P1	0			

P3: 1/3 Duty drive or 1/4 Duty drive switching control data This control data bit selects either 1/3 Duty drive or 1/4 Duty drive.

P3	Duty mode	Status of (COM4/ S41)	Reset conditions
0	1/4	COM4	0
1	1/3	S41	-

(Note 1) COM4: COMMON output S41: SEGMENT output

P2,P1: Frame frequency switching control data

These control data bits select Frame frequency setting.

Setting	P2	P1	Reset conditions				
80Hz	0	0	0				
100Hz	0	1	-				
120Hz	1	0	-				
External Clock input	1	1	-				

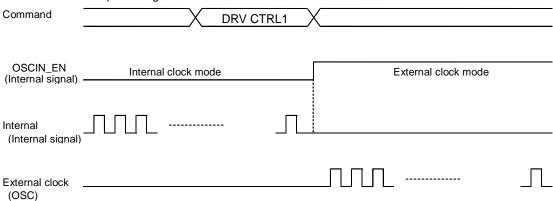
Relationships between Frame frequency (fFR) and Divide number

P2	P1	Divide	number	f <sub>FR</sub> [Hz]		
	FI	1/3 Duty	1/4 Duty	1/3 Duty	1/4 Duty	
0	0	510	512	80	80	
0	1	408	408	100	100	
1	0	342	344	120	120	
1	1	2040	2048	-	-	

Formula to calculate Frame frequency from frequency and Divide number: "Frame frequency = frequency / Divide number"

Ex) In case, 1/4 Duty mode, 
$$(P2,P1) = (0,0)$$
  
 $f_{FR} = 40.96[kHz] / 512 = 80[Hz]$   
(*Note 2*) Built-in Oscillator circuit frequency = 40.96 kHz Typ.

<External Clock input timing function>



# Detailed command description - continued

Drive Control2 (DRV CTRL2)

Ν	1SB							LSB
	D7	D6	D5	D4	D3	D2	D1	D0
	1	1	0	1	0	P2	P1	0

P2: 1/3 Bias drive or 1/2 Bias drive switching control data

This control data bit selects either 1/3 Bias drive or 1/2 Bias drive.

P2	Bias mode	Reset conditions
0	1/2	-
1	1/3	0

P1: Line Inversion or Frame Inversion switching control data

This control data bit selects either line inversion drive or frame inversion drive.

P1	Inversion mode	Reset conditions
0	Line	0
1	Frame	-

Typically, when driving large capacitance LCD, Line inversion will increase the influence of crosstalk. Regarding driving waveform, refer to LCD waveform.

Drive Control3 (DRV CTRL3)

**MSB** LSB D7 D6 D5 D4 D3 D2 D1 D0 Р3 P2 P0 1 0 0 1

(\*: Don't care)

P3 to P2: Key Scan output port/Segment output port switching control data These control data bits select Key Scan outputs or Segment outputs.

Cor Bi	ntrol ts	Output Pin State					Maximum Number of	Reset Conditions	
P3	P2	KS1/	KS2/	KS3/	KS4/	KS5/	KS6/	Input keys	Reset Conditions
. 0	. –	S42	S43	S44	S45	S46	S47		
0	0	KS1	KS2	KS3	KS4	KS5	KS6	30	-
0	1	S42	KS2	KS3	KS4	KS5	KS6	25	-
1	0	S42	S43	KS3	KS4	KS5	KS6	20	-
1	1	S42	S43	S44	S45	S46	S47	0	0

When (P3,P2)=(1,1), Keyscan doesn't function. Key scan pins are all segment outputs.

Thus, maximum segment display number and RAM last address change based on this value.

	., 0		Herit dieplay Hamber and to an last address change based on the value.								
	Control Bits		Status of Pins						Segment Number	Last A	ddress
P3	P2	KS1/ S42	KS2/ S43	KS3/ S44	KS4/ S45	KS5/ S46	KS6/ S47	1/3 Duty	1/4 Duty	1/3 Duty	1/4 Duty
0	0	KS1	KS2	KS3	KS4	KS5	KS6	123	160	28h	27h
0	1	S42	KS2	KS3	KS4	KS5	KS6	126	164	29h	28h
1	0	S42	S43	KS3	KS4	KS5	KS6	129	168	2Ah	29h
1	1	S42	S43	S44	S45	S46	S47	156	204	33h	32h

P0: Output setting for DO

This control data bit selects either open drain output or CMOS output.

P0	Setting	Reset Conditions
0	open drain output	0
1	CMOS output	-

Pull up resistor ( $1k\Omega$  to  $10k\Omega$ ) is required when selecting Open Drain Output setting for DO. Be careful the Pull up voltage not to be higher than VDD voltage.

# Detailed command description - continued

Key Data Read (KEY RD)

Ν	/ISB							LSB
	D7	D6	D5	D4	D3	D2	D1	D0
	1	0	0	0	0	1	0	1

# Display Control (DISCTRL)

Ν	1SB							LSB
	D7	D6	D5	D4	D3	D2	D1	D0
	1	1	1	1	1	0	P1	*

(\*: Don't care)

P1: Segment on/off control data

This control data bit controls the on/off state of the segments.

P1	Display status	Reset conditions
1	ON	-
0	OFF	0

#### Software Reset (SWRST)

Ν	/ISB							LSB
	D7	D6	D5	D4	D3	D2	D1	D0
	1	1	1	1	0	0	0	1

This is the Software Reset command.

After sending this command, each register, DDRAM data and DDRAM address are initialized.

# Address Set (ADSET)

٨	/ISB							LSB
	D7	D6	D5	D4	D3	D2	D1	D0
	0	1	P5	P4	P3	P2	P1	P0

Address which could be set starts from 00(Hex) until RAM last address. Setting of values other than the above is not allowed. (Otherwise, address is set to 0.) Refer to "Display Data Transfer Method" for RAM last address.

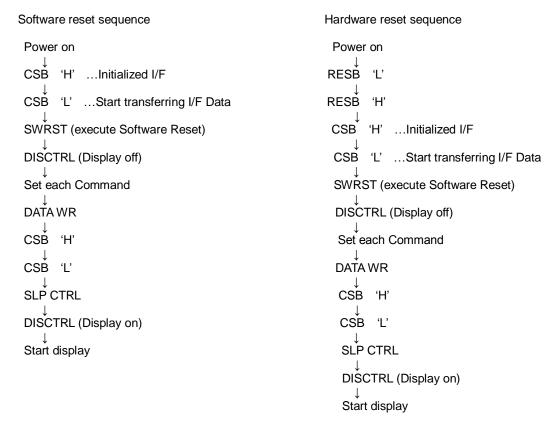
# Data Write (DATAWR)

Ν	1SB							LSB
	D7	D6	D5	D4	D3	D2	D1	D0
	0	0	0	0	1	0	1	0

Data transfer can be started by this command. Set the CSB pin to High to terminate the data transfer. Refer to "Command and Data Transfer Method".

# Initialize sequence

Recommended sequence after Power-On to set this device to initial condition.



(Note 1) Each register value, DDRAM address and DDRAM data are random condition after power on till initialize sequence is executed. (Note 2) Each register value, DDRAM address are reset by a hardware reset operation.

# **Cautions in Power-On Sequence**

Power-On Reset (POR) Circuit

This LSI has "P.O.R" (Power-On Reset) circuit and Software Reset function.

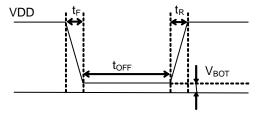
When the power is ON, IC internal circuit and reset pass through unstable low-voltage region.

Internal IC is not totally reset because VDD rises and this may result to malfunction.

Thus, POR circuit and function of software reset are installed in order to prevent this.

Please follow the following recommended Power-On sequences to allow the reset action to complete.

Set the power up conditions to meet the recommended  $t_R$ ,  $t_F$ ,  $t_{OFF}$ , and  $V_{BOT}$  spec below in order to ensure P.O.R operation.



 $t_R$ ,  $t_F$ ,  $t_{OFF}$ ,  $V_{BOT}$  recommended conditions

t <sub>R</sub>	t <sub>F</sub>	t <sub>OFF</sub>	$V_{BOT}$				
5ms	5ms	150ms	0.1V				
or less	or less	or more	or less				

Figure 23. Power ON/OFF waveform

If it is difficult to meet above conditions, execute the following sequence after Power-On.

- (1) Set CSB to High
- (2) Clear CSB to Low and then issue a SWRST command.

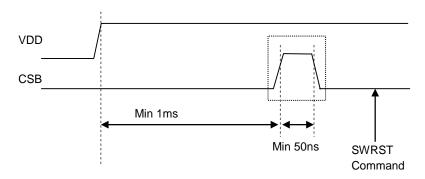


Figure 24. SWRST Command Sequence

Power Up Sequence and Power Down Sequence

To prevent incorrect display, malfunction and abnormal current,

VDD must be turned on before VLCD In power up sequence.

VDD must be turned off after VLCD In power down sequence.

Please satisfies VLCD≥VDD, t1>0ns, t2>0ns

To refrain from data transmission is strongly recommended while power supply is rising up or falling down to prevent from the occurrence of disturbances on transmission and reception.

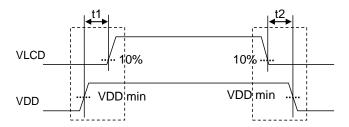


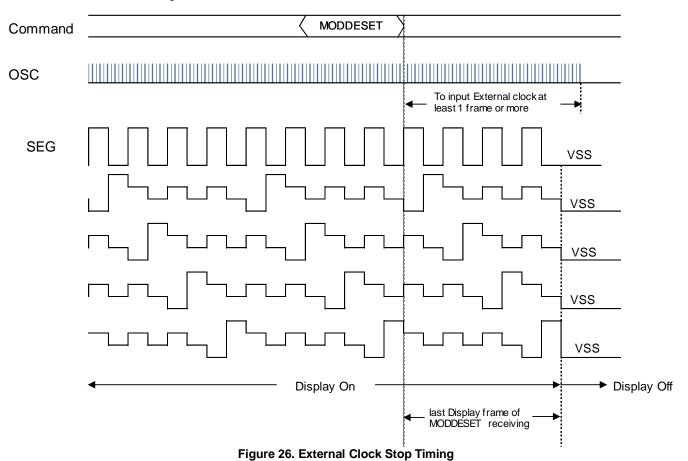
Figure 25. Power On/Off Sequence

# **Display off Operation in External Clock Mode**

After receiving DISCTRL(Display OFF) command, Segment and Common ports output VSS level synchronized with frame. Therefore, in external clock mode, it is necessary to input the external clock based on each frame frequency setting after sending DISCTRL (Display OFF). For the required number of clock, refer to Frame frequency switching control data of Drive Control1(DRV CTRL1).

Please input the external clock as below. 1/4 Duty, DRV CTRL1 [P2,P1=1,1] setting(Frame frequency [Hz] = external clock [Hz] / 2048), it needs 2048 clk or more.

Please refer to the timing chart below.



#### **DISPLAY DDRAM DATA EXAMPLE**

If LCD layout pattern is shown as in Figure 27 and 28 and DDRAM data is shown as in Table2, display pattern will be shown as in Figure 29.

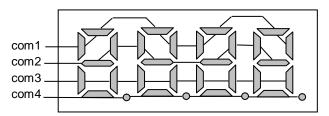


Figure 27. Example COM Line pattern

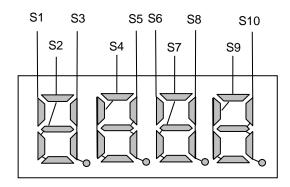


Figure 28. Example of SEG Line pattern



Figure 29. Example of display pattern

		S	S	S	S	S	S	S	S	S	S	S	S	S	S	S	S	S	S	S	S
		1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20
COM1	D0	1	1	0	1	1	1	1	0	1	1	0	0	0	0	0	0	0	0	0	0
COM2	D1	0	1	1	1	0	0	1	0	1	0	0	0	0	0	0	0	0	0	0	0
СОМЗ	D2	0	0	1	0	1	0	0	1	1	1	0	0	0	0	0	0	0	0	0	0
COM4	D3	0	1	1	0	0	0	1	0	1	0	0	0	0	0	0	0	0	0	0	0

Address

00h 01h 02h 03h 04h 05h 06h 07h 08h 09h 0Ah 0Bh 0Ch 0Dh 0Eh 0Fh 10h 11h 12h 13h

Table 2. DDRAM Data map

#### **Operational Notes**

#### 1. Reverse Connection of Power Supply

Connecting the power supply in reverse polarity can damage the IC. Take precautions against reverse polarity when connecting the power supply, such as mounting an external diode between the power supply and the IC's power supply pins.

#### 2. Power Supply Lines

Design the PCB layout pattern to provide low impedance supply lines. Separate the ground and supply lines of the digital and analog blocks to prevent noise in the ground and supply lines of the digital block from affecting the analog block. Furthermore, connect a capacitor to ground at all power supply pins. Consider the effect of temperature and aging on the capacitance value when using electrolytic capacitors.

#### 3. Ground Voltage

Ensure that no pins are at a voltage below that of the ground pin at any time, even during transient condition.

#### 4. Ground Wiring Pattern

When using both small-signal and large-current ground traces, the two ground traces should be routed separately but connected to a single ground at the reference point of the application board to avoid fluctuations in the small-signal ground caused by large currents. Also ensure that the ground traces of external components do not cause variations on the ground voltage. The ground lines must be as short and thick as possible to reduce line impedance.

#### 5. Recommended Operating Conditions

These conditions represent a range within which the expected characteristics of the IC can be approximately obtained. The electrical characteristics are guaranteed under the conditions of each parameter.

#### 6. Inrush Current

When power is first supplied to the IC, it is possible that the internal logic may be unstable and inrush current may flow instantaneously due to the internal powering sequence and delays, especially if the IC has more than one power supply. Therefore, give special consideration to power coupling capacitance, power wiring, width of ground wiring, and routing of connections.

#### 7. Operation Under Strong Electromagnetic Field

Operating the IC in the presence of a strong electromagnetic field may cause the IC to malfunction.

#### 8. Testing on Application Boards

When testing the IC on an application board, connecting a capacitor directly to a low-impedance output pin may subject the IC to stress. Always discharge capacitors completely after each process or step. The IC's power supply should always be turned off completely before connecting or removing it from the test setup during the inspection process. To prevent damage from static discharge, ground the IC during assembly and use similar precautions during transport and storage.

#### 9. Inter-pin Short and Mounting Errors

Ensure that the direction and position are correct when mounting the IC on the PCB. Incorrect mounting may result in damaging the IC. Avoid nearby pins being shorted to each other especially to ground, power supply and output pin. Inter-pin shorts could be due to many reasons such as metal particles, water droplets (in very humid environment) and unintentional solder bridge deposited in between pins during assembly to name a few.

#### 10. Unused Input Terminals

Input terminals of an IC are often connected to the gate of a MOS transistor (CMOS?). The gate has extremely high impedance and extremely low capacitance. If left unconnected, the electric field from the outside can easily charge it. The small charge acquired in this way is enough to produce a significant effect on the conduction through the transistor and cause unexpected operation of the IC. So unless otherwise specified, unused input terminals should be connected to the power supply or ground line.

# **Operational Notes - continued**

#### 11. Regarding the Input Pin of the IC

In the construction of this IC, P-N junctions are inevitably formed creating parasitic diodes or transistors. The operation of these parasitic elements can result in mutual interference among circuits, operational faults, or physical damage. Therefore, conditions which cause these parasitic elements to operate, such as applying a voltage to an input pin lower than the ground voltage should be avoided. Furthermore, do not apply a voltage to the input pins when no power supply voltage is applied to the IC. Even if the power supply voltage is applied, make sure that the input pins have voltages within the values specified in the electrical characteristics of this IC.

#### 12. Ceramic Capacitor

When using a ceramic capacitor, determine the dielectric constant considering the change of capacitance with temperature and the decrease in nominal capacitance due to DC bias and others.

#### 13. Area of Safe Operation (ASO)

Operate the IC such that the output voltage, output current, and power dissipation are all within the Area of Safe Operation (ASO).

#### 14. Thermal Shutdown Circuit(TSD)

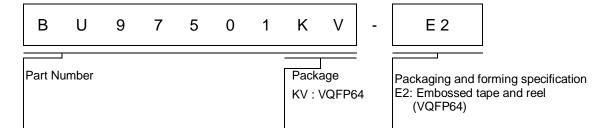
This IC has a built-in thermal shutdown circuit that prevents heat damage to the IC. Normal operation should always be within the IC's power dissipation rating. If however the rating is exceeded for a continued period, the junction temperature (Tj) will rise which will activate the TSD circuit that will turn OFF all output pins. When the Tj falls below the TSD threshold, the circuits are automatically restored to normal operation.

Note that the TSD circuit operates in a situation that exceeds the absolute maximum ratings and therefore, under no circumstances, should the TSD circuit be used in a set design or for any purpose other than protecting the IC from heat damage.

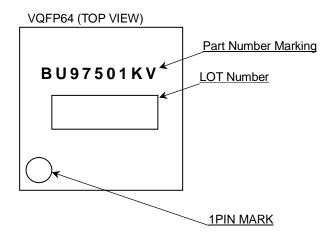
#### 15. Over Current Protection Circuit (OCP)

This IC incorporates an integrated overcurrent protection circuit that is activated when the load is shorted. This protection circuit is effective in preventing damage due to sudden and unexpected incidents. However, the IC should not be used in applications characterized by continuous operation or transitioning of the protection circuit.

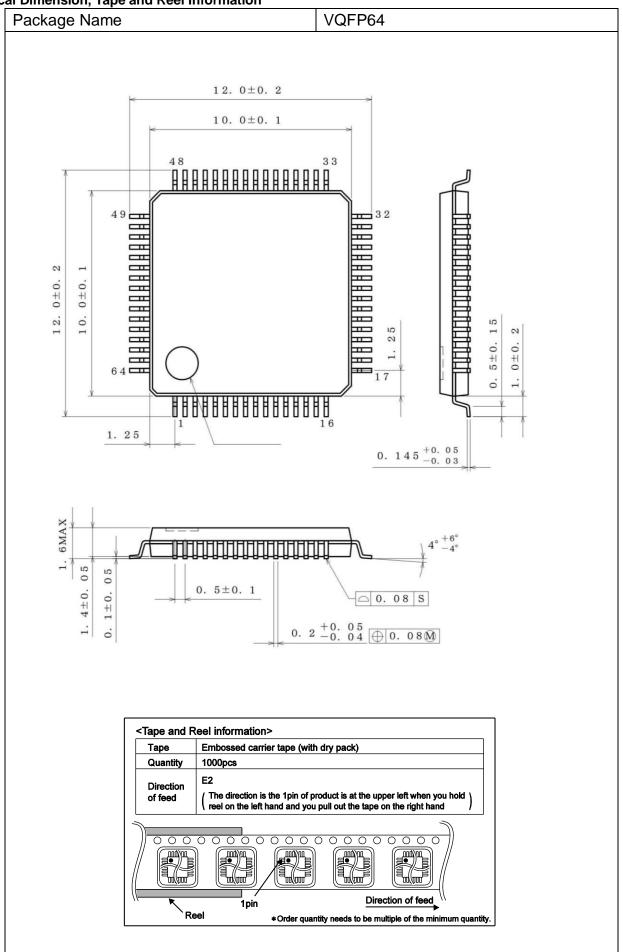
# **Ordering Information**



# **Marking Diagram**



**Physical Dimension, Tape and Reel Information** 



Revision	History								
Version	date	description							
001	07. Aug. 2013								
002	07. Nov. 2013	Page.4 Add Electrical Characteristics of External Clock Frequency							
003		Page.2 Modify Pin Description OSC, DO, RESB, VSS and S1/P1 to S4/P4 Functions Page.3 Modify Absolute Maximum Ratings Power Dissipation Page.3 Modify Electrical Characteristics precondition Page.3 Modify Electrical Characteristics LCD Bias Voltage VMID1 Conditions Page.4 Modify Electrical Characteristics External Clock Frequency Symbol Page.4 Modify Pipical temperature characteristics VDD condition Page.4 Modify MPU Interface Characteristics VDD condition Page.4 Modify Figure 5 Title Page.5 Modify Command Transfer Method description Page.6 Modify Command Transfer Method description Page.6 Modify Command Transfer Method description Page.6 Modify Display Data Transfer Method description Page.10 Modify Serial Data Output description Page.11 Modify Serial Data Output description Page.11 Modify Serial Data Output description Page.11-12 Modify Key Scan Operation description Page.14-17 Modify LCD Driver Bias/Duty Circuit figure Page.18 Modify Table name Page.19 Minor translation change Sleep Control command description to have more conformity between Japanese and English version Page.20 Minor translation change Segment Control command description to have more conformity between Japanese and English version Page.20 Minor translation change Drive Control1 command description to have more conformity between Japanese and English version Page.21 Minor translation change Drive Control2 command description to have more conformity between Japanese and English version Page.21 Minor translation change Drive Control3 command description to have more conformity between Japanese and English version Page.21 Minor translation change Seftware command description to have more conformity between Japanese and English version Page.22 Minor translation change Seftware command description to have more conformity between Japanese and English version Page.22 Minor translation change Seftware command description to have more conformity between Japanese and English version Page.22 Minor translation change Address command description to have mor							
004		Page.11 Add f <sub>OSC</sub> explanation when External clock input Page.12 Add f <sub>OSC</sub> explanation when External clock input Page.24 Add the condition when power up and power down							
005	20. Jan. 2015	Page.24 Add the condition when power up and power down							
006	12. Feb. 2019	<ul> <li>Page.2 Modify "I/O" of OSC in Pin Description.</li> <li>Page.2 Separate "I/O" and "Handling when unused" of KI1/S48 to KI5/S52 to input terminal and output terminal from input and output terminal in Pin Description.</li> <li>Page.3 Delete temperature condition in Absolute Maximum Ratings.</li> <li>Page.3 Move Operational Temperature Range to Recommended Operating Conditions</li> <li>Page.3 Add Caution 2 in Absolute Maximum Ratings.         <ul> <li>(Transcription from Thermal Consideration in Operational Notes)</li> </ul> </li> <li>Page.4 Add "External Clock Rise Time", "External Clock Fall Time" and "External Clock Duty" in Oscillation Characteristics.</li> <li>Page.5 Add descriptions in MPU Interface Characteristics.</li> <li>Page.21 Add External Clock input timing function in Drive Control1 (DRV CTRL1)</li> <li>Page.22 Add descriptions in Drive Control2 (DRV CTRL2).</li> <li>Page.25 Add descriptions in Power Up Sequence and Power Down Sequence.</li> <li>Page.26 Add Display off Operation in External Clock Mode.</li> <li>Page.28 Delete Thermal Consideration (Move to Absolute Maximum Ratings)</li> </ul>							

# **Notice**

#### **Precaution on using ROHM Products**

1. Our Products are designed and manufactured for application in ordinary electronic equipment (such as AV equipment, OA equipment, telecommunication equipment, home electronic appliances, amusement equipment, etc.). If you intend to use our Products in devices requiring extremely high reliability (such as medical equipment (Note 1), transport equipment, traffic equipment, aircraft/spacecraft, nuclear power controllers, fuel controllers, car equipment including car accessories, safety devices, etc.) and whose malfunction or failure may cause loss of human life, bodily injury or serious damage to property ("Specific Applications"), please consult with the ROHM sales representative in advance. Unless otherwise agreed in writing by ROHM in advance, ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of any ROHM's Products for Specific Applications.

(Note1) Medical Equipment Classification of the Specific Applications

JAPAN	USA	EU	CHINA		
CLASSⅢ	CL ACCIII	CLASS II b	CLASSIII		
CLASSIV	CLASSII	CLASSⅢ			

- 2. ROHM designs and manufactures its Products subject to strict quality control system. However, semiconductor products can fail or malfunction at a certain rate. Please be sure to implement, at your own responsibilities, adequate safety measures including but not limited to fail-safe design against the physical injury, damage to any property, which a failure or malfunction of our Products may cause. The following are examples of safety measures:
  - [a] Installation of protection circuits or other protective devices to improve system safety
  - [b] Installation of redundant circuits to reduce the impact of single or multiple circuit failure
- 3. Our Products are designed and manufactured for use under standard conditions and not under any special or extraordinary environments or conditions, as exemplified below. Accordingly, ROHM shall not be in any way responsible or liable for any damages, expenses or losses arising from the use of any ROHM's Products under any special or extraordinary environments or conditions. If you intend to use our Products under any special or extraordinary environments or conditions (as exemplified below), your independent verification and confirmation of product performance, reliability, etc, prior to use, must be necessary:
  - [a] Use of our Products in any types of liquid, including water, oils, chemicals, and organic solvents
  - [b] Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
  - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl<sub>2</sub>, H<sub>2</sub>S, NH<sub>3</sub>, SO<sub>2</sub>, and NO<sub>2</sub>
  - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
  - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
  - [f] Sealing or coating our Products with resin or other coating materials
  - [g] Use of our Products without cleaning residue of flux (Exclude cases where no-clean type fluxes is used. However, recommend sufficiently about the residue.); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
  - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse, is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

#### Precaution for Mounting / Circuit board design

- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

#### **Precautions Regarding Application Examples and External Circuits**

- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
- 2. You agree that application notes, reference designs, and associated data and information contained in this document are presented only as guidance for Products use. Therefore, in case you use such information, you are solely responsible for it and you must exercise your own independent verification and judgment in the use of such information contained in this document. ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of such information.

#### **Precaution for Electrostatic**

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

# **Precaution for Storage / Transportation**

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
  - [a] the Products are exposed to sea winds or corrosive gases, including Cl<sub>2</sub>, H<sub>2</sub>S, NH<sub>3</sub>, SO<sub>2</sub>, and NO<sub>2</sub>
  - [b] the temperature or humidity exceeds those recommended by ROHM
  - [c] the Products are exposed to direct sunshine or condensation
  - [d] the Products are exposed to high Electrostatic
- Even under ROHM recommended storage condition, solderability of products out of recommended storage time period
  may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is
  exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

#### **Precaution for Product Label**

A two-dimensional barcode printed on ROHM Products label is for ROHM's internal use only.

#### **Precaution for Disposition**

When disposing Products please dispose them properly using an authorized industry waste company.

#### **Precaution for Foreign Exchange and Foreign Trade act**

Since concerned goods might be fallen under listed items of export control prescribed by Foreign exchange and Foreign trade act, please consult with ROHM in case of export.

#### **Precaution Regarding Intellectual Property Rights**

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#### **General Precaution**

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